

SUPER FAST DIODE MODULE TYPE 600A
Features

High Surge Capability
 Type 600V V_{RRM}
 Isolation Type Package
 Electrically Isolation base plate

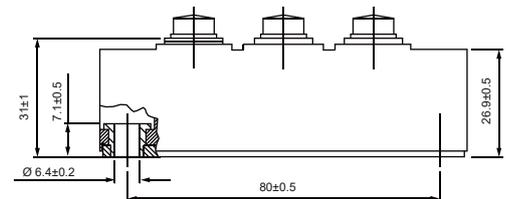
HEAVY THREE TOWER KA

Maximum Ratings

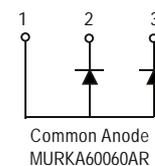
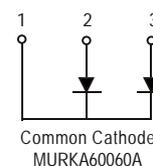
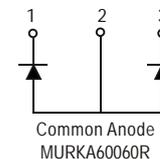
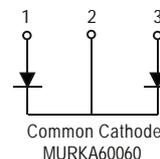
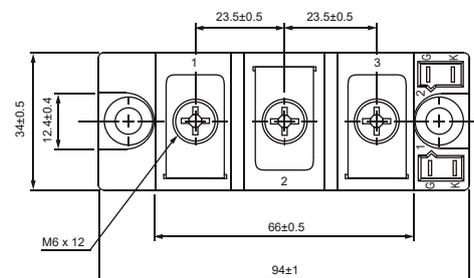
Operating Temperature : -55°C to $+175^{\circ}\text{C}$
 Storage Temperature : -55°C to $+175^{\circ}\text{C}$

| Part Number | Maximum Recurrent Peak Reverse Voltage | Maximum RMS Voltage | Maximum DC Blocking Voltage |
|------------------|--|---------------------|-----------------------------|
| MURKA60060(A)(R) | 600V | 420V | 600V |

Dimensions in mm (1 mm = 0.0394")


Electrical Characteristics @ 25 °C Unless Otherwise Specified

| | | | |
|--|------------------|--|---|
| Average Forward Current (Per pkg) | $I_{F(AV)}$ | 600A | $T_C = 100^{\circ}\text{C}$ |
| Peak Forward Surge Current (Per diode) | I_{FSM} | 6000A | 8.3ms , half sine |
| Maximum Instantaneous Forward Voltage * (Per diode) | V_F | 1.4V | $I_{FM} = 300\text{A}; T_J = 25^{\circ}\text{C}$ |
| Maximum Instantaneous Reverse Current At Rated DC Blocking Voltage* (Per diode) | I_R | 50 μA 5 mA | $T_J = 25^{\circ}\text{C}$ $T_J = 125^{\circ}\text{C}$ |
| Maximum Reverse Recovery Time (Per diode) | T_{rr} | 200ns | $I_F = 0.5\text{A}, I_R = 1.0\text{A}, I_{RR} = 0.25\text{A}$ |
| Isolation Voltage | V_{isol} | 3000V | A.C. 1minute |
| Maximum Thermal Resistance Junction To Case | $R_{\theta j c}$ | 0.14 $^{\circ}\text{C}/\text{W}$ 0.28 $^{\circ}\text{C}/\text{W}$ | Per pkg Per diode |
| Mounting torque | M_d | 2.5±0.5Nm 4.5±0.5Nm | To heatsink To terminal |



*Pulse Test: Pulse Width 300 μsec , Duty Cycle < 2%

Figure .1- Typical Forward Characteristics

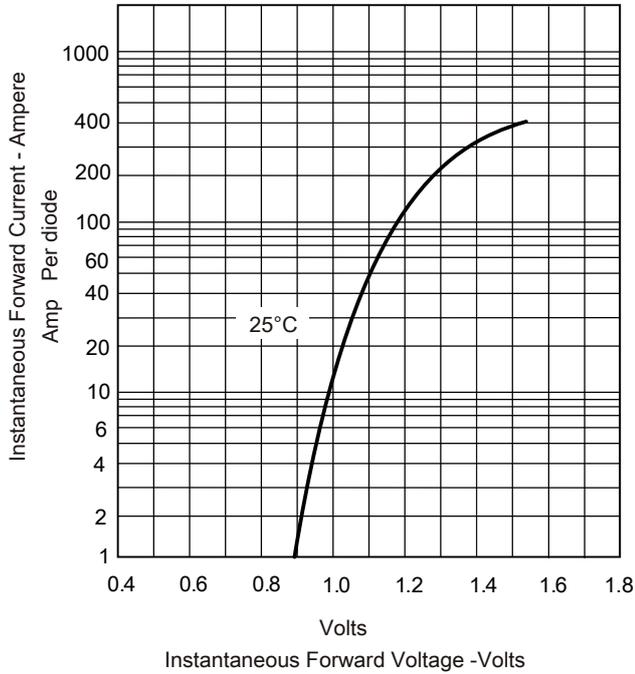


Figure .2-Forward Derating Curve

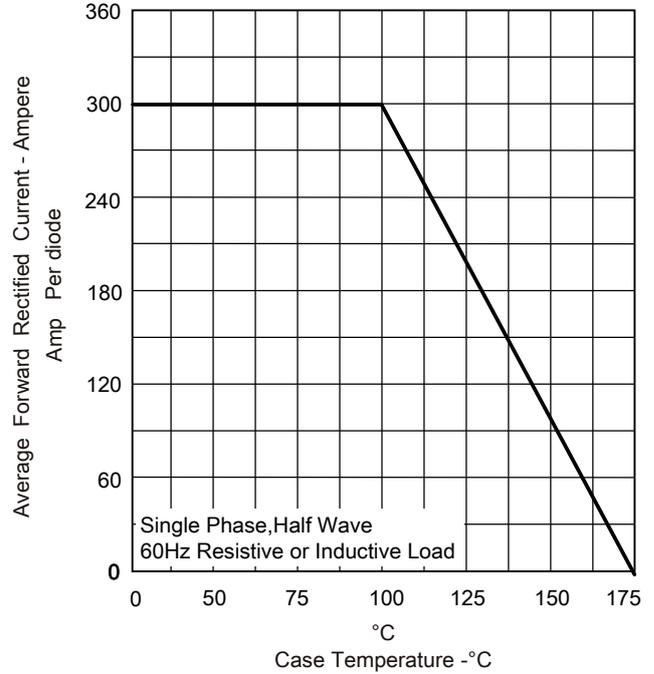


Figure .3- Peak Forward Surge Current

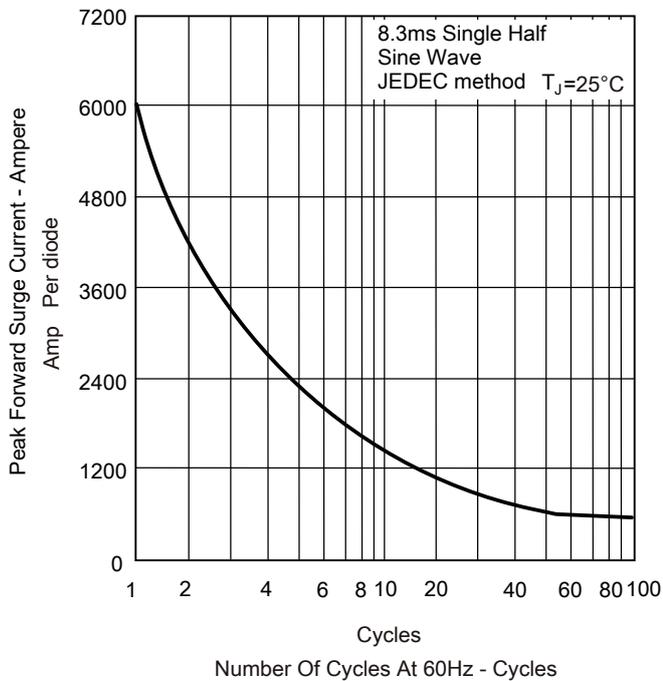
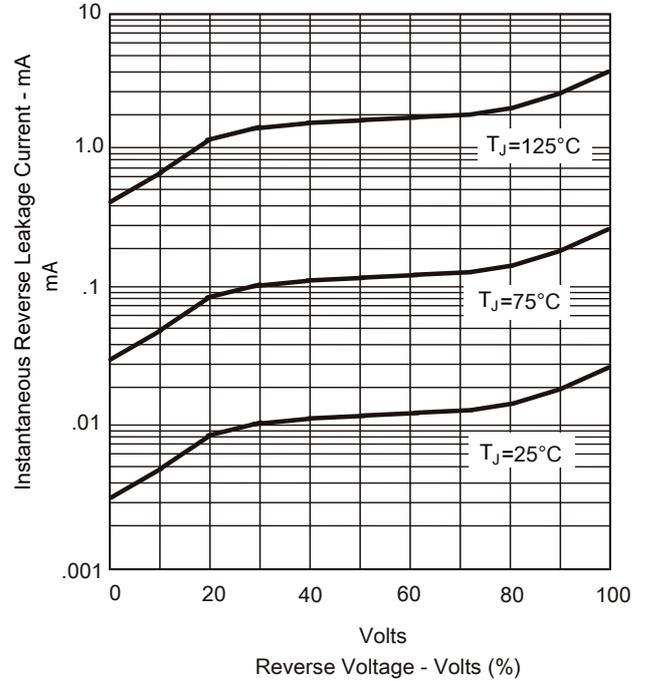


Figure .4- Typical Reverse Characteristics



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